



Product Change Notification

Change Notification #: 115871 - 02
Change Title: Intel® Compute Card CD1M3128MK,
PCN 115871-02, Product Marking, Label,

**Laser Etching Change and Label Update,
Reason for Revision: Adding additional
regulatory markings to the box label and
enclosure laser etching. No changes to
current shipping carton label.**

Date of Publication: November 09, 2017

Key Characteristics of the Change:

Product Marking, Label

Forecasted Key Milestones:

| | |
|---|--------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | Nov 10, 2017 |
|---|--------------|

Description of Change to the Customer:

Reason for Revision: Adding additional regulatory markings to the box label and enclosure laser etching. No changes to current shipping carton label.

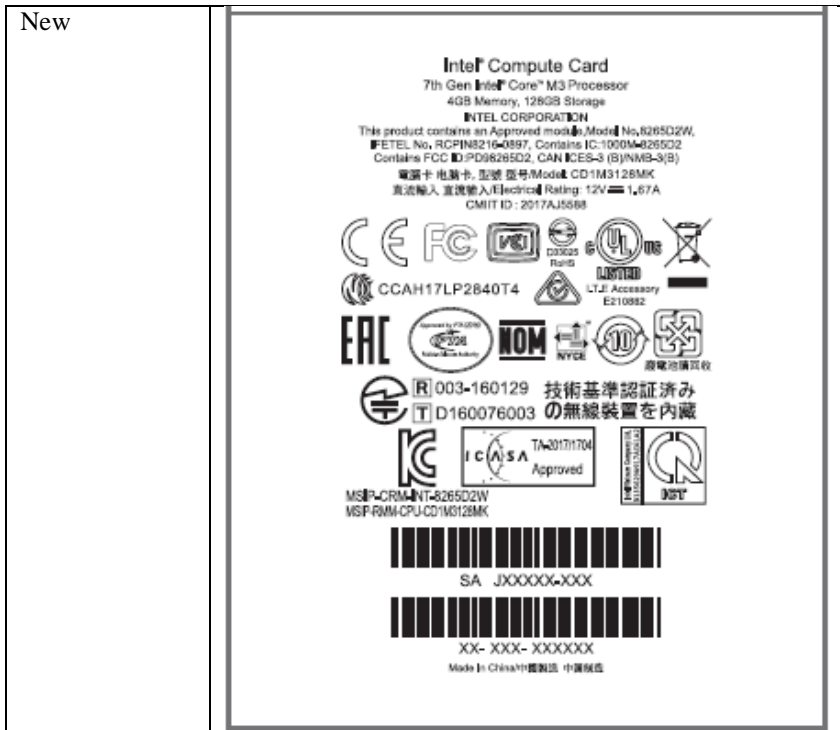
The Intel® Compute Card SKU listed in the products affected below will have the following changes.

1. The label on the box is being updated to include additional regulatory markings. See pictures below for Current and New images.

| Current | New |
|---|---|
|  <p>Intel® Compute Card Product Code: BLKCD1M3128MK S/N: G6MK73300005 MAC Address: A0AFBD6B1C82 Version#: J38723-502 Date of Manufacture: 30 AUG 2017 Made In China</p> <p>CE, FC, RoHS, UL LISTED I.T.E. Accessory E210882, 10, 95D693-ND4007</p> |  <p>Intel® Compute Card Product Code: BLKCD1M3128MK S/N: G6MK743000C9 MAC Address: A0AFBD6B1787 Version#: J38723-502 Date of Manufacture: 2 NOV 2017 Made In China</p> <p>CE, FC, RoHS, UL LISTED I.T.E. Accessory E210882, 10, KC, ICSA TA-20171704 Approved, MSIP-CRM-INT-8265D2W, MSIP-RMM-CPU-CD1M3128MK, 95D693-ND4007</p> |

2. The enclosure's laser etching is being updated. See pictures below for Current and New images.

| Current | |
|---------|---|
| |  <p>Intel® Compute Card 7th Gen Intel® Core™ i3 Processor 4GB Memory, 128GB Storage INTEL CORPORATION This product contains an Approved module Model No 8265D2W IPTEL No. ROPN8216-0897, Contains IC:1000M-8265D2 Contains FCC ID PD98265D2, CAN ICES-3 (B)/NMB-3(B) Electrical Rating: 12V, max 1.67A Model: CD1M3128MK</p> <p>CE, FC, RoHS, UL LISTED I.T.E. Accessory E210882, 10, CCAH17LP2840T4, 003-160129, D160076003, 技術基準認証済みの無線装置を内蔵, SA J38723-502, S/N G6MK733000AG, Made In China</p> |



Customer Impact of Change and Recommended Action:

The changes to the Laser etching, box labels, and carton labels, have no impact on the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre Change TA | Pre Change SA | Post Change TA | Post Change SA |
|---------------|--------|---------------|---------------|----------------|----------------|
| BLKCD1M3128MK | 954730 | J67772-101 | J38723-502 | J67772-102 | J38723-503 |

PCN Revision History:

| Date of Revision: | Revision Number: | Reason: |
|-------------------------|------------------|--|
| October 27, 2017 | 00 | Originally Published PCN |
| November 1, 2017 | 01 | Reason for Revision: Adding adhesive to components, and additional regulatory markings to the booklet, box label, enclosure laser etching, and carton label. |
| November 9, 2017 | 02 | Adding additional regulatory markings to the box label and enclosure laser etching. No changes to current shipping carton label. |



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115871 - 02

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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